



# Automotive Solutions for Telematics & Networking



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# Smart Mobility

It is estimated that 80% of all innovations in the automotive industry today are directly or indirectly enabled by electronics. With vehicle functionality improving with every new model this means a continuous increase in the semiconductor content per car.

With over 30 years' experience in automotive electronics, ST is a solid, innovative, and reliable partner with whom to build the future of transportation.

ST's Smart Mobility products and solutions are making driving safer, greener and more connected through the combination of several of our technologies.

**80%**  
of all innovations  
in the automotive  
industry today  
are enabled by  
electronics



## SAFER

Driving is safer thanks to our Advanced Driver Assistance Systems (ADAS) – vision processing, radar, imaging and sensors, as well as our adaptive lighting systems, user display and monitoring technologies.

## GREENER

Driving is greener with our automotive processors for engine management systems, high-efficiency smart power electronics at the heart of all automotive sub-systems and devices for hybrid and electric vehicle applications.

## MORE CONNECTED

Vehicles are more connected using our infotainment and telematics processors and sensors, as well as our radio tuners and amplifiers, positioning technologies, and secure vehicle-to-vehicle (V2V) and vehicle-to infrastructure (V2X) connectivity solutions.

ST supports a wide range of automotive applications, from Powertrain for ICE, Chassis and Safety, Body and Convenience to Telematics and Infotainment, paving the way to the new era of car electrification, advanced driving systems and secure car connectivity.

# Telematics and Networking



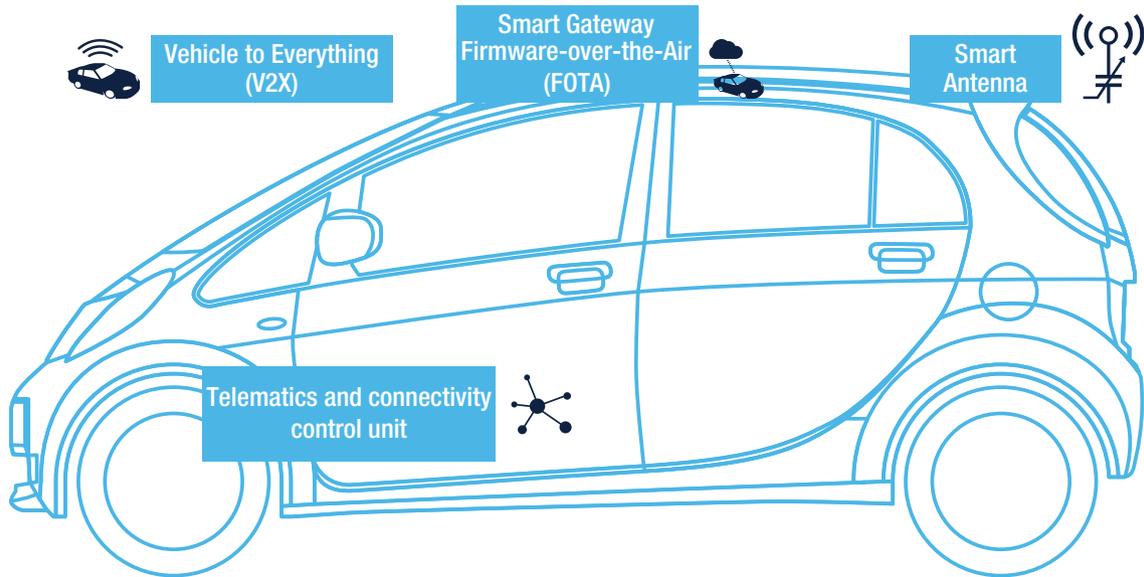
**ST**  
covers a wide  
selection of  
telematics and  
networking  
devices

Connectivity is revolutionizing the vehicles on our roads. Connectivity to the cloud and cloud-based services benefit occupants but also manufacturers by enabling over-the-air software upgrades and predictive maintenance. The increasing count of electronic control units (ECUs) for safety, engine management, motor control, infotainment all need to be networked, upgradeable and secure. In-car connectivity for occupants, Wi-Fi or Bluetooth needs to fit seamlessly with the other networks. Vehicle-to-Vehicle (V2V) and Vehicle-to-Everything (V2X) communication channels need to be secured and linked with a telematics gateway.

ST's product range covers a wide selection of telematics and networking devices from the most accurate GNSS positioning products to powerful multicore telematics processors with embedded security modules, from sensors for vehicle acceleration/deceleration monitoring and crash detection to smart gateways enabling Firmware-over-the-Air (FOTA) updates.

To provide you with the car connectivity solutions you need, we leverage our extensive hardware and software expertise and our partnerships with market leader

## KEY APPLICATIONS



## SOLUTIONS

ST's key products and solutions for Telematics and Networking applications include:

GNSS	Bluetooth and Connectivity	Power Management	Telematics & Secure Processors, 32-bit Automotive Microcontrollers
Secure Connectivity	Sensors	EOS and ESD Protection, EMI filters	
HW & SW development and evaluation tools			



**FIND OUT MORE**  
[www.st.com/telematics-and-networking](http://www.st.com/telematics-and-networking)

Vehicle-to-Everything (V2X)  
 Smart Antenna

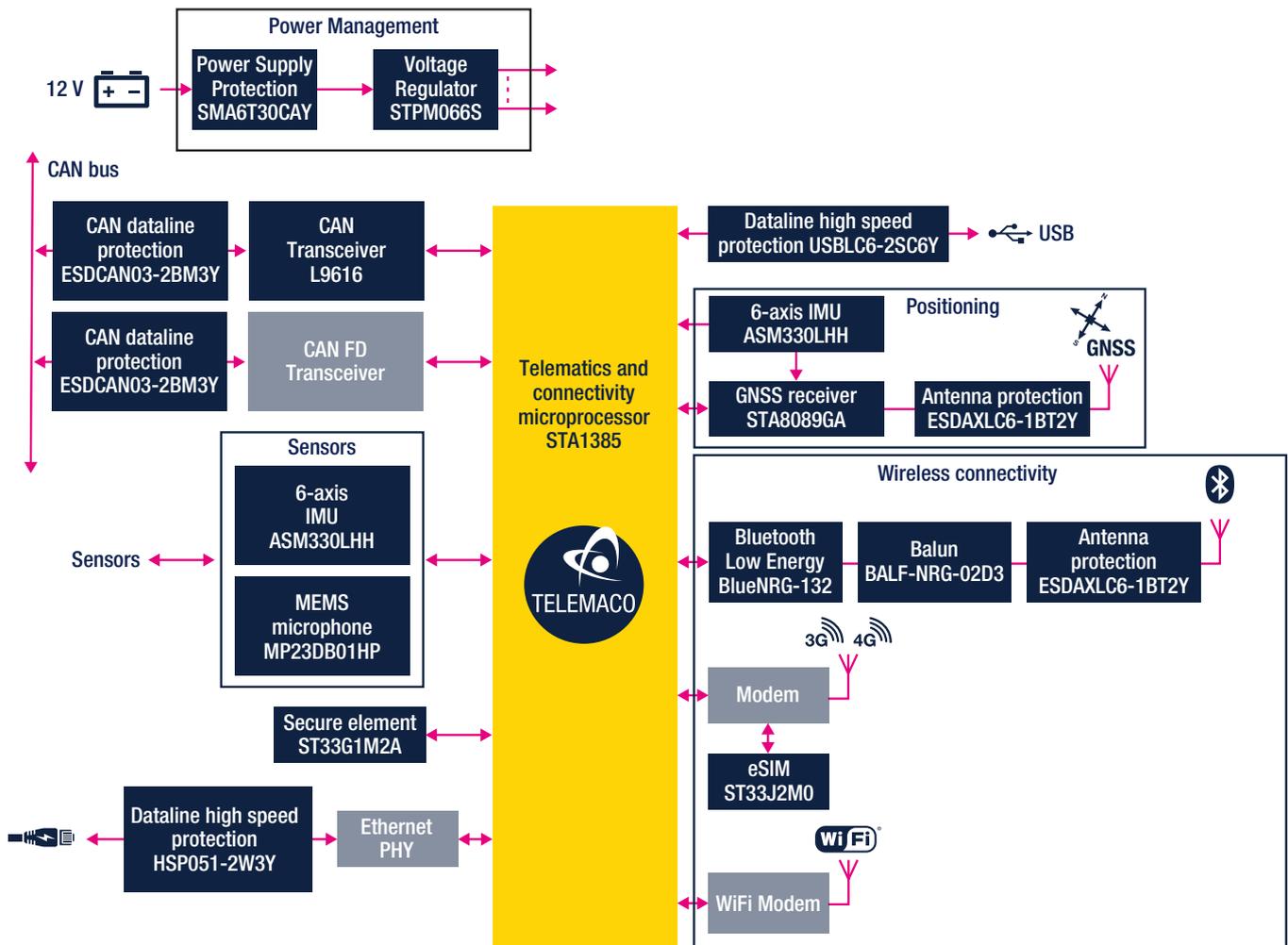
Telematics and Connectivity Control Unit  
 Smart Gateway Firmware Over-the-Air (FOTA)

## TELEMATICS AND CONNECTIVITY CONTROL UNIT

Interfacing with a variety of in-vehicle data and control buses and ensuring their security is the key challenge in designing an automotive telematics unit.

The Connectivity and Networking Control Unit is at the heart of the complex telematics systems present in today's vehicle architectures. It needs to provide all the intra-system connectivity to a number of modules or sub-systems such as wideband cellular modems and wireless connectivity modules (Bluetooth, Wi-Fi, etc.).

ST has a wide offer that includes application-specific standard products (ASSPs), embedded software and a full range of cost-optimized scalable system-on-chip (SoC) solutions for telematics control units (TCU) featuring a complete set of standard interfaces and security solutions.



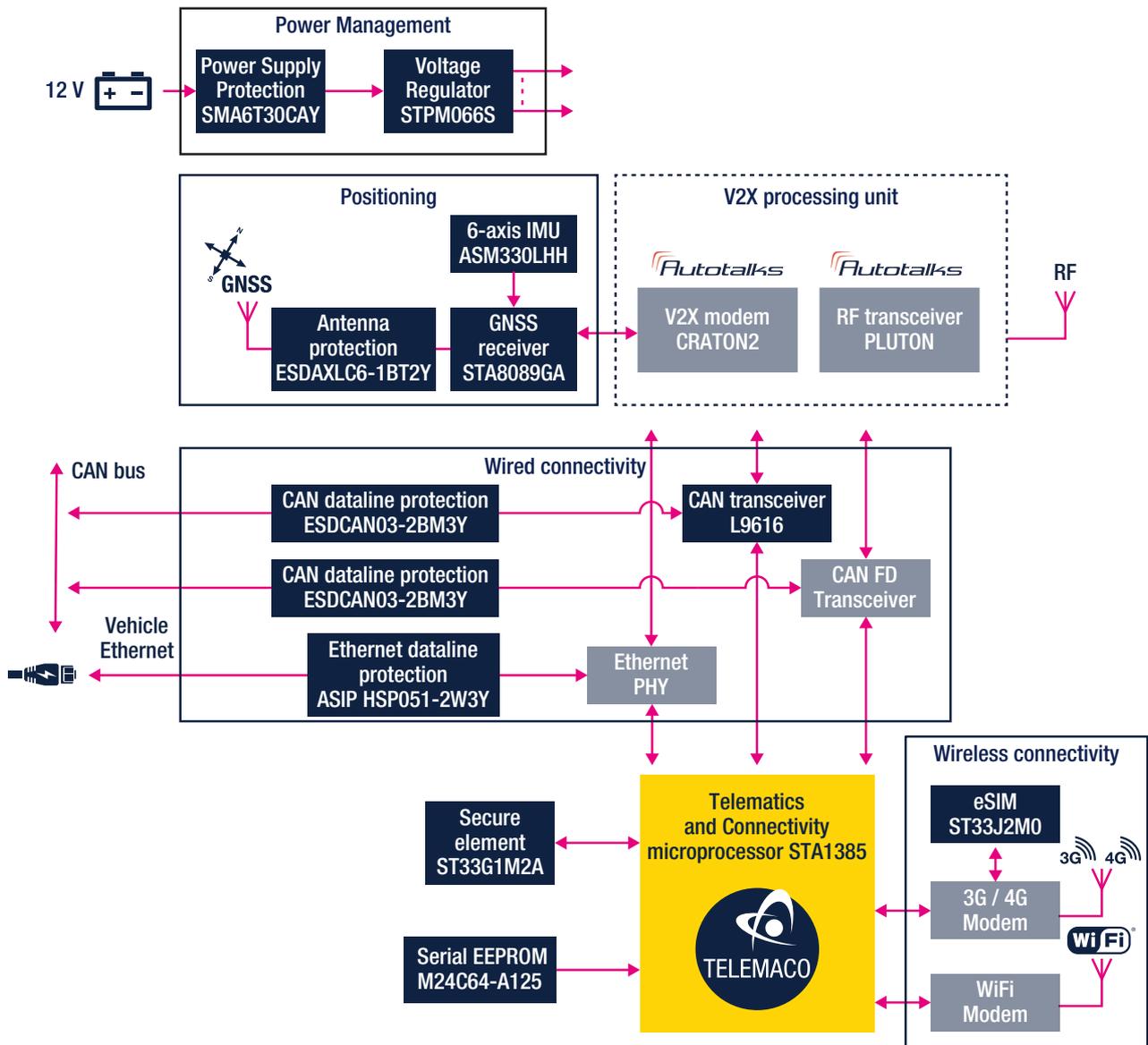
**FIND OUT MORE**  
[www.st.com/telematics-and-connectivity-cu](http://www.st.com/telematics-and-connectivity-cu)

## VEHICLE-TO-EVERYTHING (V2X)

Vehicle-to-vehicle (V2V) and vehicle-to-infrastructure (V2I) communications, collectively referred to as vehicle-to-everything (V2X), is a wireless technology aimed at enabling data exchanges between a vehicle and its surroundings. V2X technology, operating at 5.9 GHz, is specifically defined for fast moving objects and enables the establishment of a reliable radio link, even in non-line-of-sight conditions.

By sharing data, such as their position and speed, to surrounding vehicles and infrastructures, V2X systems improve driver awareness of upcoming potential dangers and dramatically improve collision avoidance, resulting in heavily reduced fatalities and injury severity. In addition, this technology enhances traffic efficiency by providing warnings for upcoming traffic congestions, proposing alternative routes and ensuring eco-friendly driving, reducing CO<sub>2</sub> emissions through adaptive cruise control and a smarter transportation management.

ST has a long-term partnership with Autotalks – a V2X chipset market pioneer – for the co-development of a Global V2X solution supporting both DSRC (dedicated short-range communication) and C-V2X direct communications in a single automotive-qualified chipset, allowing the shortest time-to-market for a V2X solution that supports both standards.

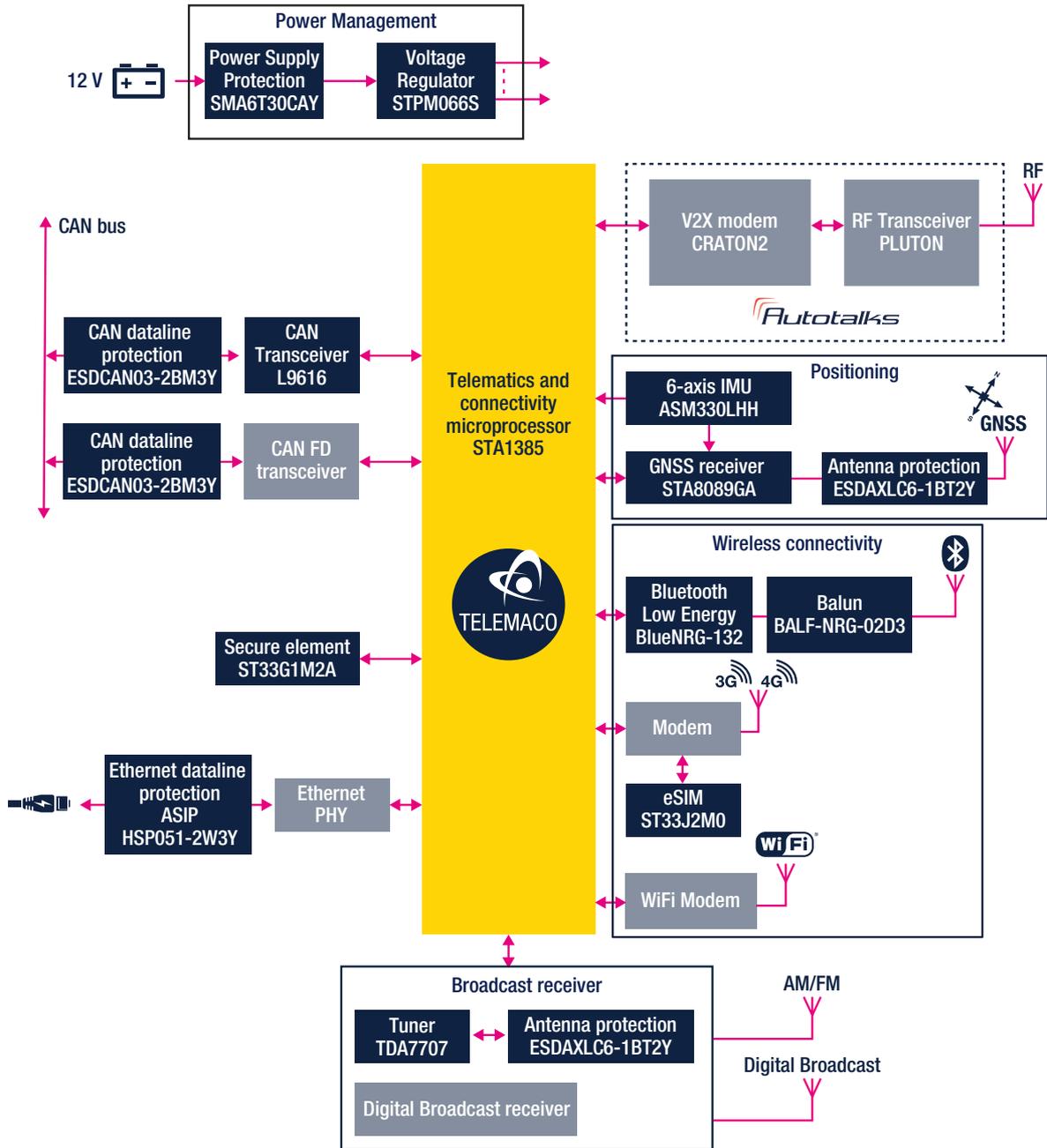


**FIND OUT MORE**  
[www.st.com/vehicle-to-everything-v2x](http://www.st.com/vehicle-to-everything-v2x)

## SMART ANTENNA

Vehicles today combine an ever-increasing number of wireless connectivity and positioning technologies: Wi-Fi, for in-car hot-spots, Bluetooth, 3G/LTE cellular, IEEE 802.11 WLAN systems for Vehicle-to-Everything (V2X) and GNSS positioning.

Managing the requirements of all the underlying radio links and signal processing requirements are a challenge for system designers. Smart antenna systems ease the system design issues and ST has a range of products to support them. We offer a range of leading-edge processors, GNSS receivers, sensors and a complete family of pin-to-pin compatible terrestrial tuners.



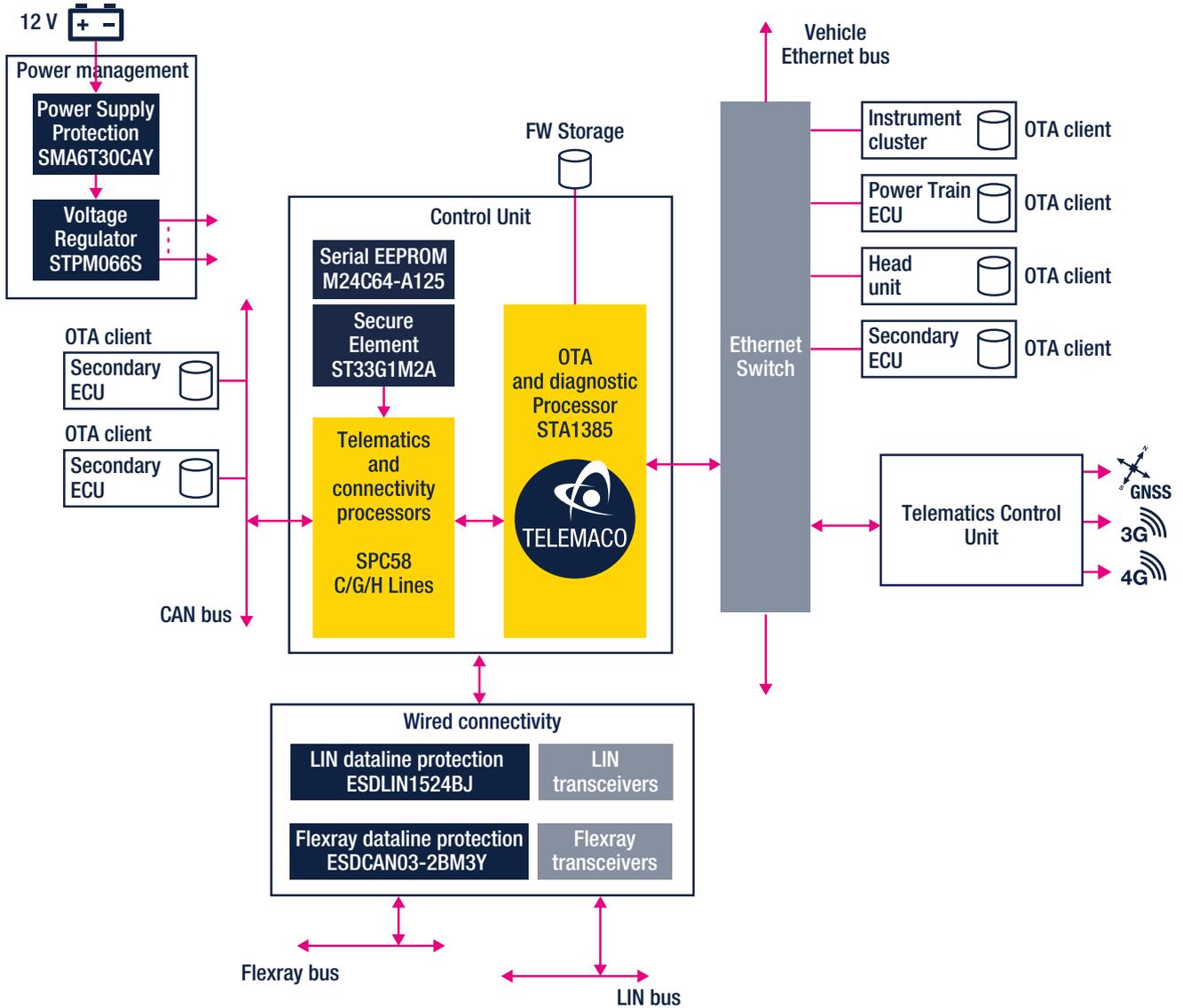
**FIND OUT MORE**  
[www.st.com/smart-antenna](http://www.st.com/smart-antenna)

## SMART GATEWAY & FIRMWARE OVER-THE-AIR (FOTA)

Firmware-over-the-Air (FOTA) services enable firmware downloads and updates for any of the specific electronic control units (ECUs) inside a car. With the number of ECUs in vehicles increasing, sharing diagnostic and operational data from on-board systems and components can help car makers reduce recall expenses, increase product quality and operational efficiency, as well as deliver post-sale vehicle performance and feature enhancements.

More importantly, updates need resilience to cyberattacks and cybersecurity is of paramount importance.

We offer a full range of telematics processors, 32-bit microcontrollers and secure elements, ensuring the highest level of security and helping protect vehicles from malicious attacks.



**FIND OUT MORE**

[www.st.com/firmware-over-the-air](http://www.st.com/firmware-over-the-air)

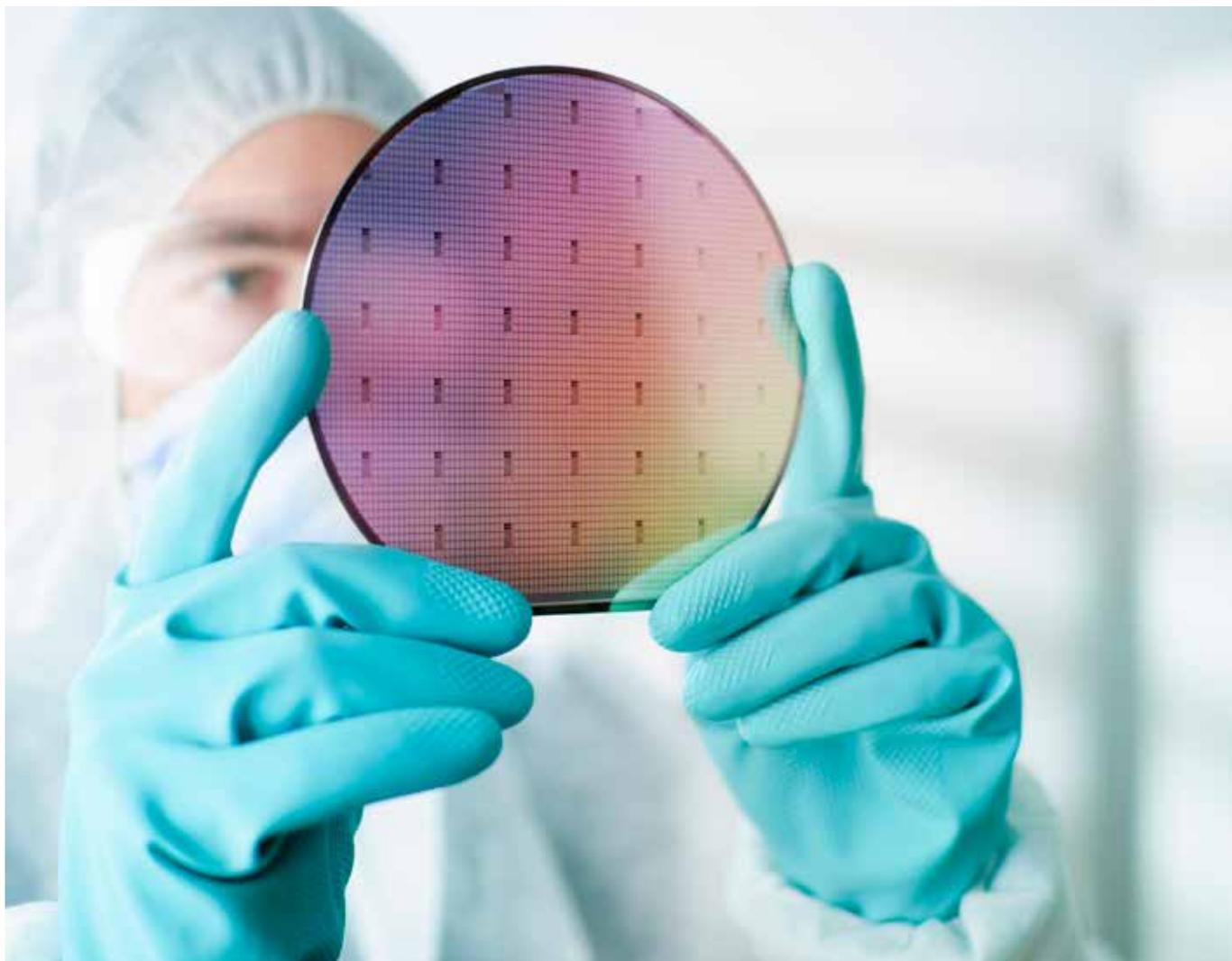
# Key Technologies

## RESEARCH & DEVELOPMENT AND MANUFACTURING

To keep its technology edge, ST maintains a strong commitment to innovation, with approximately 9,000 people working in R&D and product design and spending about 12% of its revenue in R&D. Among the industry's global technology leaders, ST owns and continuously refreshes a substantial patent library with over 19,500 active and pending patents. The company also uses its over 200 R&D partnerships to further foster its innovation.

ST draws on a rich pool of chip-manufacturing technologies, including advanced FD-SOI (Fully Depleted Silicon-on-Insulator) CMOS (Complementary Metal Oxide Semiconductor), differentiated Imaging technologies, RF-SOI (RF Silicon-On-Insulator), BiCMOS, BCD (Bipolar, CMOS, DMOS), Si MOSFET, SiC MOSFET, Si IGBT, VIPower, Transil, Trench Schottky Diodes, and MEMS technologies.

ST believes in the benefits of owning manufacturing facilities and operating them in close proximity to its R&D operations. ST has a worldwide network of front-end (wafer fabrication) and back-end (assembly and test and packaging) plants. ST's principal wafer fabs are located in Agrate Brianza and Catania (Italy), Crolles, Rousset, and Tours (France), and in Singapore. These are complemented by assembly-and-test facilities located in China, Malaysia, Malta, Morocco, the Philippines, and Singapore.



## KEY TECHNOLOGIES FOR AUTOMOTIVE PRODUCTS

### CMOS (Complementary Metal Oxide Semiconductor)

CMOS (Complementary Metal Oxide Semiconductor) is a pure digital technology invented in the 60's. It is largely used in digital products for processing purposes. Starting from CMOS, other technologies have been set up including BCD (Bipolar-CMOS-DMOS) used for mixed signal products, FD-SOI that allows to reduce silicon geometries below 28nm, and embedded NVM at the heart of MCUs. The robustness and versatility of this technology, present in billions of devices, makes it very suitable for all automotive applications.

### FD-SOI / RF-SOI

Fully Depleted Silicon-on-Insulator, or FD-SOI, is a planar process technology that delivers the benefits of reduced silicon geometries while actually simplifying the manufacturing process. The buried oxide layer, specific to FD-SOI MOS, lowers the parasitic capacitances and efficiently confines the electrons flowing from the source to the drain, dramatically reducing performance degrading for leakage currents. This is a key advantage for pure digital products, especially when required to operate at high temperature, allowing very innovative power management techniques. The advanced ADAS platforms are based on this technology and produced in Crolles 300 facility on a 28nm node. Moreover, thanks to the tight electrostatic control of the transistor, FD-SOI is recognized as a leading technology for low-power, RF and millimeter-wave applications.

Associated with the high-density PCM embedded non-volatile memory, ST offers a unique platform for automotive applications.

Key applications include ADAS, RF switches and tuners, low-noise amplifiers, power amplifiers, monolithic integrated RF and FEMs (switches, LNAs, PAs and passives).

### NON-VOLATILE MEMORIES (eNVM)

ST has a strong background in non-volatile memories (NVM) and has developed embedded NVM technologies to enable real-time MCUs and other products that benefit from real-time access to NVM. Today, automotive volumes are at 90 nm and 40 nm technology nodes, and the new Stellar MCU family uses phase-change memory (PCM) to exploit the features of CMOS FD-SOI technology. This evolution to PCM places ST at the forefront of automotive MCUs.

ST standalone non-volatile memories (NVM) are also highly regarded in the industry, especially our automotive serial EEPROM, which is ideal for high-quality and flexible parameter storage, with a wide portfolio ranging from 1 Kbit to 4 Mbits. The automotive Serial EEPROM is robust, high-performance, and designed for intensive operation at high temperatures, making it suitable for all high-reliability applications. The EEPROM is AEC-Q100 qualified, screened through a specific high-reliability testing flow, and PPAP Level 3 compliant. The EEPROM is manufactured in 150 nm technology nodes and is progressively extending to 110 nm. The I<sup>2</sup>C, SPI, and Microwire buses are supported for three packages: SO8N, TSSOP8, and DFN8 up to 150°C.

### BCD (BIPOLAR-CMOS-DMOS)

BCD (BIPOLAR-CMOS-DMOS) is a key technology for power ICs. BCD combines the strengths of three different process technologies onto a single chip: Bipolar for precise analog functions, CMOS (Complementary Metal Oxide Semiconductor) for digital design and DMOS (Double Diffused Metal Oxide Semiconductor) for power and high-voltage elements.

This combination of technologies brings many advantages: improved reliability, reduced electromagnetic interference and smaller chip area.

BCD has been widely adopted and continuously improved to address a broad range of products and applications in the fields of power management, analog data acquisition and power actuators.

**FD-SOI**



**EEPROM**

## VIPower

Vertical Intelligent Power (VIPower) is a technology developed by ST and in production since 1991. VIPower technology provides control, protection and diagnostics for medium/high power automotive loads. The technology combines Vertical Double Diffused MOS Power devices with their own temperature and current sensors and CMOS and HV components for power, analog, and mixed-signal designs.

VIPower technology plays a key role in the move towards electric vehicles. The smart 48 V networks used in mild- and full-hybrid cars require intelligent power switches to drive high- and low-sided loads and electric motors, with very low losses and high current sense accuracy, all monitored via the connections to the ECU microcontroller.

The new VIPower M0-9 SPI drivers feature full digital diagnostics with embedded ADC for load current sensing. These new devices implement sophisticated software logic that also simplifies AUTOSAR compatibility.

Designed to replace standard melting fuses in automotive power distribution systems, our new STi2Fuse smart switches feature wire harness protection on top of the typical high-side driver functions for additional savings on component and production costs, while extending EV range and reducing the carbon footprint of vehicles.



## TRANSIL

TRANSIL is a key planar technology for our Automotive transient voltage suppressors (TVS) designed to protect automotive sensitive circuits against surges as defined in ISO 7637-2 and ISO 16750 also called load-dump (battery lines), ISO 7637-3 (data lines) and ESD as defined in ISO 10605. Protection is also provided against other perturbations generated by elements like ignition, relay contacts, alternators, injectors, SMPS, etc.

This technology is compatible with high-end circuits where low leakage current and high junction temperatures are required to provide reliability and stability over time.



## Data line ESD protection

ST's automotive data line ESD protection devices include transient voltage suppressors (TVS) and application-specific discrete devices that provide system level protection against ESD surges according to standard IEC 61000-4-2. ESD protection devices are manufactured using automotive-grade processes and qualified to AEC-Q101 standards. As such, they can address all automotive applications and domains including advanced driver-assistance systems (ADAS), vehicle-to-everything (V2X), CAN-FD, SerDes (serializer/deserializer), and Ethernet Base-T standards to name just a few, in order to achieve immunity with the very low clamping voltage. Moreover, ST offers innovative, miniature wettable flank DFN packages to ease Automatic Optical Inspection (AOI).

## A growing and diversified portfolio of MEMS and sensor solutions

Enabling the transition to a sustainable Onlife era, ST offers an extensive MEMS sensor portfolio based on more than 25 years of experience and innovation. Moreover, our new generation of MEMS sensors features an embedded intelligent sensor processing unit (ISPU) to help meet the challenges of incorporating AI into energy-saving Edge-based applications.



Our sensors offer three key attributes:

- Capable of directly processing the data they capture and delivering meaningful insights in the local device, **smart sensors** reduce transmitted data and cloud processing requirements, thus lowering power consumption at the system level.
- Able to interface with other sensor applications, our **open sensors** let third parties benefit from ST's in-sensor processing innovations, while building an ecosystem to jointly create value for customers.
- Providing high-precision data that allows better quality decisions and makes interactions smoother and more natural, our **accurate sensors** also reduce factory calibration time and resources, which also reduces energy needs.

To reduce design costs and effort for a more rapid time to market, our comprehensive ecosystem includes helpful developer resources with ready-to-use boards as well as software tools and real-life example code.

# Development Tools

## EVALUATION BOARDS, eDESIGN SUITE, AND SOFTWARE TOOLS

ST provides a set of eDesign suites tuned to the needs of the Automotive Industry. Once the appropriate products have been selected, a wide range of samples and evaluation boards are available to help you get started and reduce your development times. In addition to boards, ST provide schematics, BOM and Gerber files to facilitate your hardware design and demonstration software packages are also available.

### Evaluation kits

Product evaluation kits help you design, test, and calibrate your automotive application. A wide range of boards is available to evaluate the specific features of products and solutions in their applications. A complete set of documents and resources including circuit diagrams and bills of material as well as reference guides is available. Additional software including ready-to-use example code and user-friendly GUIs complete our offer.



**FIND OUT MORE**  
[www.st.com/automotive-evalboards](http://www.st.com/automotive-evalboards)

## eDesignSuite

eDesignSuite is a comprehensive set of easy-to-use design-aid utilities ready to help you streamline the system development process with a wide range of ST products.



### TwisterSIM

TwisterSIM is an off-line Electro-Thermal simulator for our VIPower automotive power devices. It helps shorten design solution cycle by enabling complex evaluations including load-compatibility, wiring harness optimization, fault condition impact and diagnostic behavior analysis and Dynamic Thermal performance.



### STPOWER Studio

The STPOWER Studio dynamic electro-thermal simulation software offers comprehensive power and thermal analysis for a growing number of STPOWER devices. It helps users select the best power device for the specific application mission profile and predicts device behavior under given operating conditions.



### Rectifier diodes simulator

With just a few clicks our on-line FERD & Schottky diode simulator lets you estimate power losses based on application waveforms and select the best components for your solution.



### AC switch simulator

Our AC switch simulator provides graphs of estimated temperature and voltage blocking capabilities to so you can quickly determine the best switch for your solution.



### TVS simulator

Simply specify the surge input waveform and system ratings to be protected and this intuitive simulator lets you sort and select the best TVS protection for your design.



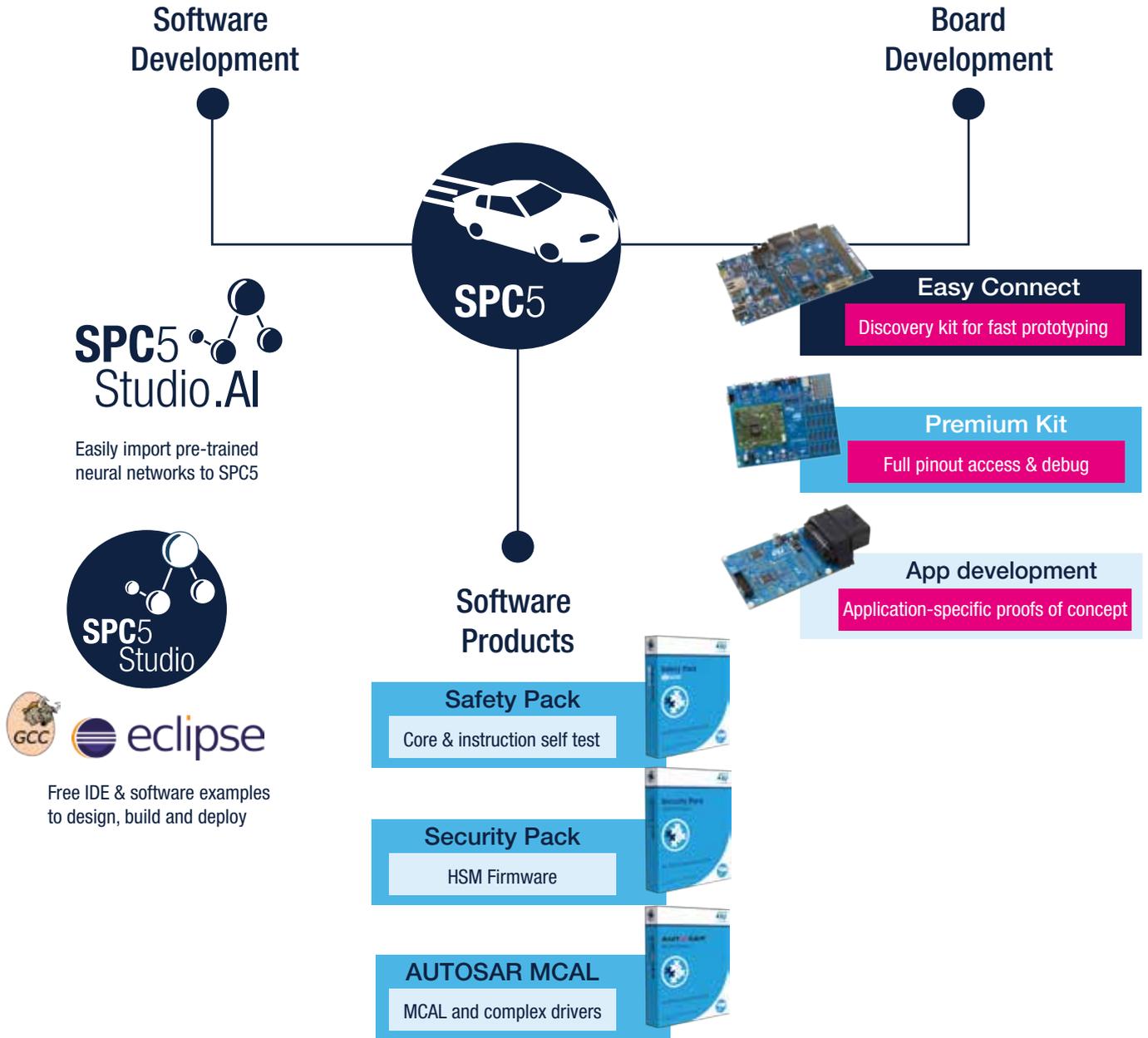
**FIND OUT MORE**  
[www.st.com/edesign](http://www.st.com/edesign)

# COMPREHENSIVE SPC5 AUTOMOTIVE MCU DEVELOPMENT ECOSYSTEM

A rich ecosystem with a full set of hardware and software tools allows developers to save time, simplify implementation, quickly prototype their application and benefit from ready-to-use boards and example code. ST offers a wide set of hardware kits ranging from quick evaluation tools to modular and professional boards for developing final proofs-of-concept.

Together with free downloadable SPC5Studio Integrated Development Enviroments (IDE), engineers can easily set up application projects in a short time. SPC5Studio contains a wide selection of example code for starting projects. Additionally, ST offers a set of licensed software packs addressing Safety, Security and AUTOSAR MCAL components.

ST's network of 3rd parties and partners complement the offer with hardware, such as debugger probes, and software tools including compilers and other services.



Software Development

Board Development

**SPC5 Studio.AI**

Easily import pre-trained neural networks to SPC5

**SPC5 Studio**

**gcc** **eclipse**

Free IDE & software examples to design, build and deploy

**SPC5**

Software Products

**Safety Pack**  
Core & instruction self test

**Security Pack**  
HSM Firmware

**AUTOSAR MCAL**  
MCAL and complex drivers

**Easy Connect**  
Discovery kit for fast prototyping

**Premium Kit**  
Full pinout access & debug

**App development**  
Application-specific proofs of concept



**FIND OUT MORE**  
[www.st.com/auto-sp5-mcu-evaltools](http://www.st.com/auto-sp5-mcu-evaltools)

## STELLARLINK FAST PROTOTYPING FOR AUTOMOTIVE MCUs

StellarLINK is a USB to JTAG passive debugger dongle for Automotive MCUs. It supports SR5, SR6, and SPC5 automotive microcontrollers and their evaluation boards. StellarLINK is Integrated into StellarStudio and SPC5Studio

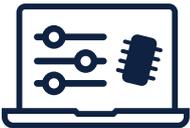
ST programmer & debugger



Supporting Stellar SR5, SR6, and SPC5 MCUs



Plug & Play with evaluation boards



Extending Stellar & SPC5 ecosystem



Eco-friendly packaging



**FIND OUT MORE**

[www.st.com/en/development-tools/stellarlink.html](http://www.st.com/en/development-tools/stellarlink.html)

## SPC5 SOFTWARE TOOLS



SPC5Studio is a built-on Eclipse plug-in development environment offering a very intuitive and customizable framework to build and deploy embedded applications for SPC5 Power architecture 32-bit microcontrollers.

Integrating software development tools, device configuration tools and examples, SPC5Studio is a complete solution to speed up project development.

Available free for download on the [st.com](https://www.st.com) website.



SPC5Studio includes **SPC5Studio.AI**, a plug-in for Artificial intelligence-based applications, a seamless way to generate, execute and validate pre-trained NN models on automotive MCUs.

Pre-trained neural networks can be automatically generated into an efficient “ANSI C” library that can be compiled, installed and executed.

Pre-trained neural networks can be easily imported by SPC5Studio.AI from the most widely used deep learning frameworks, such as Keras, TensorFlow Lite, Lasagne, Caffe, ConvNetJS, and ONNX.

## SOFTWARE PRODUCTS



**SPC5 Security Pack** provides basic capabilities to support root-of-trust (RoT) where private encryption keys are kept secret during the microcontroller lifetime using a dedicated location inside the OTP space. To further ensure application security, encryption and decryption functionalities are fully executed on the HSM core.



**SPC5 Safety Pack** is a comprehensive software package rigorously developed according to an ISO 26262-compliant development process, and helps developers achieve the required safety target, up to the most rigorous ASIL-D level. It includes a Safety kit for the Microcontroller Abstraction Layer (MCAL) as well as Core self-test programs that implement safety counter-measures to ensure compliance with MCU ASIL level requirements.



**SPC5 AUTOSAR MCAL Driver** offers a full set of Microcontroller Abstraction Layer software components in addition to Complex Device Drivers (CDD) to support specific hardware peripherals. MCAL software components are developed in house, through an ISO 26262-certified development process. ST’s CDD and MCAL drivers are integrated by 3rd party partners with all the components required for the AUTOSAR architecture including basic software layer and OS, offering a complete off-the-shelf AUTOSAR solution.

ST Security Pack, Safety Pack and AUTOSAR MCAL Pack are licensed products.

## AutoDevKit AUTOMOTIVE DEVELOPMENT INITIATIVE

AutoDevKit is a fast growing toolset for Automotive & Transportation Application Development. It allows design engineers to quickly build their prototype combining hardware, firmware and software in an easy way and fully supported by our community.

Our ecosystem offers a wide selection of Automotive MCU and devices covering several automotive applications:

- Battery management systems (BMS)
- Logistics and delivery robots
- AI on standard MCUs
- Internal and external lighting
- Power distribution
- Audio generation and AVAS
- Motor control: door control, side mirror, tailgate and seat adjustment
- HVAC, ventilation, and air quality
- USB type-C power delivery



Once the MCU platform and the functions needed for the application are selected, the developer can start from existing demo codes and customize them using high-level programming, without going into deep technical details.

The automatic pin configuration and the visual procedure enable an easy board assembling with the correct wiring and the embedded debug allows to get a working prototype quickly.

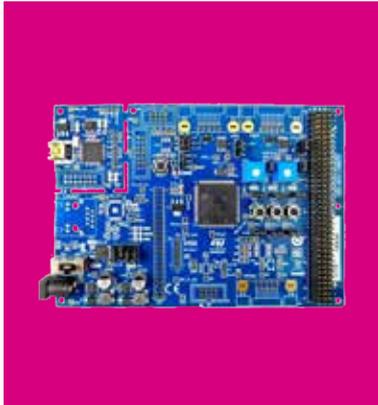


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[www.st.com/autodevkit](http://www.st.com/autodevkit)

## THE AUTODEVKIT ECOSYSTEM INCLUDES:

- MCU Discovery and Functional boards
- System solution and demonstrators
- Embedded software and firmware components and tools

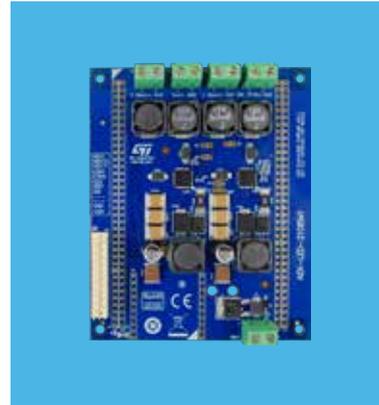
**MCU Boards**



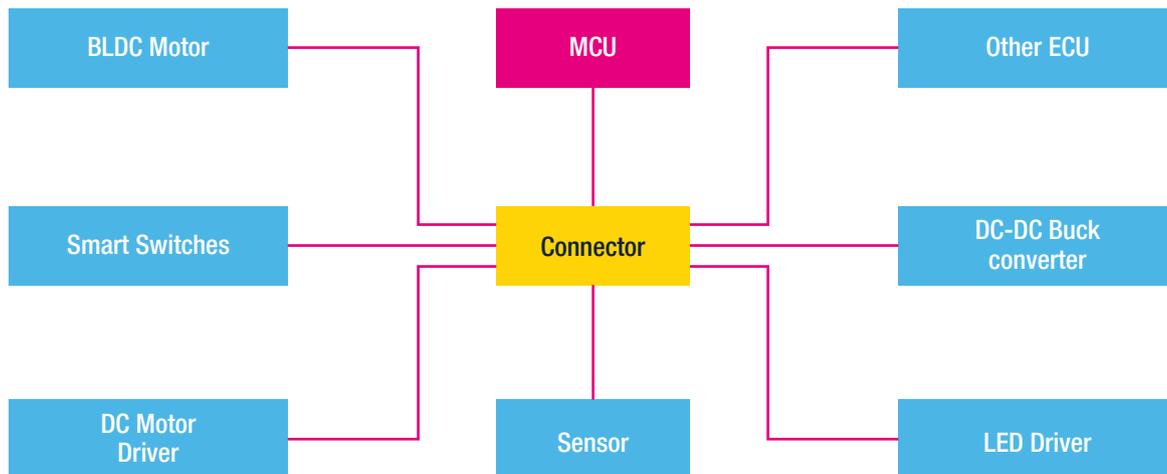
**Connector Boards**



**Functional Boards**



### Solution /Demonstrator KIT



MCU + Connector + Functional boards

# life.augmented



Order code: BR2309AUTOTEN

For more information on ST products and solutions, visit [www.st.com](http://www.st.com)

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